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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE FEB 10 2004

Application Serial No. OFFICE OF PETITIONS
Confirmation No. 2639
Filing Date February 5, 2002
Inventor H. Daniel Dulman
Assignee Micron Technology, Inc.
Group Art Unit 1756
Examiner Stephen D. Rosasco
Attorney's Docket No. MI22-1829
Customer No. 021567
Title: Radiation Patterning Tools, And Methods Of Forming Radiation Patterning Tools

**PETITION FOR WITHDRAWAL FROM ISSUE UNDER 37 C.F.R. § 1.313(c)(2) FOR
CONSIDERATION OF A REQUEST FOR CONTINUED EXAMINATION IN
COMPLIANCE WITH 37 C.F.R. § 1.114**

To: Mail Stop 313(c)
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

From: David G. Latwesen, Ph.D. (Tel. 509-624-4276; Fax 509-838-3424)
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PETITION

Applicant hereby petitions for withdrawal of this application from issue pursuant
to 37 C.F.R. § 1.313(c)(2).

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130.00 DP

PATENT ISSUE FEE

The issue fee for this case was paid on January 6, 2004. The issue date of the
patent is not yet scheduled.

REASON FOR WITHDRAWAL REQUEST

Applicant hereby petitions the Commissioner to withdraw this case from issue for consideration of a request of continued examination in compliance with 37 C.F.R. § 1.114.

The request for continued examination is submitted herewith. The request for continued examination is accompanied by an Information Disclosure Statement, and numerous references which Applicant requests be considered in determining the patentability of the claims. The undersigned became aware of the listed references only within the last few days. To insure compliance with Rule 56, Applicant hereby submits this Petition. It seems prudent to reopen prosecution so that the references can be appropriately considered by the Examiner, and for this reason Applicant believes withdrawal of the application from issue is appropriate.

PETITION FEES

A petition fee of \$130.00, as required under 37 C.F.R. § 1.17(h), is submitted herewith.

Respectfully submitted,

Dated: 2/9/09

By: David G. Latwesen

David G. Latwesen, Ph.D.
Reg. No. 38,533